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AMENDMENTS TO THE CLAIMS

Please amend Claims 1, 3, 18 and 19 as indicated below.

 (Currently Amended) A process of growing a thin film of Al₂O₃ on a substrate in a reaction chamber by a sequential vapor deposition process comprising a plurality of cycles, each cycle comprising:

exposing the part substrate in the reaction chamber to gaseous trimethyl aluminum (TMA):

stopping provision of the gaseous TMA;

removing gaseous TMA from the reaction chamber;

exposing the-part substrate in the reaction chamber to atomic oxygen; and removing atomic oxygen from the reaction chamber,

wherein in each cycle more than one monolaver of Al₂O₃ is formed.

- 2. (Original) The process of claim 1, wherein in each cycle a layer of Al_2O_3 3 Å thick is formed.
- (Currently Amended) The process of Claim 1, wherein the <u>atomic oxygen is</u> radicals are-generated remotely in a radical generator.
- (Original) The process of Claim 1, wherein the process is carried out at room temperature.
 - 5. 17. (Cancelled)
- 18. (Currently Amended) A process of growing a thin film of Al₂O₃ on a substrate in a reaction chamber by a sequential vapor deposition process comprising a plurality of cycles, each cycle comprising:

exposing the part substrate in the reaction chamber to gaseous trimethyl aluminum (TMA);

stopping provision of the gaseous TMA;

removing gaseous TMA from the <u>reaction</u> chamber; and exposing the part substrate in the reaction chamber to atomic oxygen.

19. (Currently Amended) The process of Claim 18, wherein the <u>atomic oxygen is</u>

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(Previously Presented) The process of Claim 18, wherein the process is carried 20. out at room temperature.